



Performance and Plans for the Silicon Pixel Upgrade of the STAR Experiment at RHIC

*Spiros Margetis*¹ for the STAR Collaboration

¹Kent State University, USA



The 2015 International Conference on Applications of Nuclear Techniques Crete, Greece June 14-20, 2015



Outline





- STAR Heavy Flavor Tracker (HFT)
 3 sub-detectors
- PXL Detector
 - First MAPS¹ based vertex detector
- HFT status and performance
- Summary and Outlook



STAR HFT STAR Heavy Flavor Tracker (HFT) Upgrade

Built to identify mid rapidity Charm and Beauty mesons and baryons through direct reconstruction and measurement of the displaced vertex with excellent pointing resolution.



STAR HFT

Silicon Strip Detector (SSD)

- Double sided silicon strip modules with 95 µm pitch
- Existing detector with new faster electronics
- Radius: 22 cm
- Radiation length 1% X₀
- 20 ladders from the old SSD detector
- Upgrade readout from 200 Hz to 1 kHz
- New:
 - 40 ladder cards on detector
 - 5 New RDO cards
 - Upgraded cooling system (air cooled)



Intermediate Silicon Tracker (IST)

- Single sided double-metal silicon pad with 600 µm x 6 mm pitch
- Radius: 14 cm
- Liquid cooling
- Radiation length <1.5% X₀



- Conventional Si pad detector using CMS APV chip for ladders
- Readout system copy of STAR FGT detector system
 - G. Visser et al. A Readout System Utilizing the APV25 ASIC for the Forward GEM Tracker in STAR, IEEE Real Time Conference Record, Berkeley, CA, 2012

AR HFT

PXL detector



- + MAPS sensors with 20.7 μm pitch
- Radius: ~2.8 and ~8 cm
- Radiation length <0.4% X_0 in inner layer

first MAPS based vertex detector at a collider experiment





| DCA Pointing resolution * | (12 ⊕ 24 GeV/p·c) μm |
|--|--|
| Layers | Layer 1 at 2.8 cm radius Layer 2 at 8 cm radius |
| Pixel size | 20.7 μm X 20.7 μm |
| Hit resolution | 3.7 μm (6 μm geometric) |
| Position stability | 6 μm rms (20 μm envelope) |
| Radiation length first layer | $X/X_0 = 0.39\%$ (Al conductor cable) |
| Number of pixels | 356 M |
| Integration time (affects pileup) | 185.6 μs |
| Radiation environment | 20 to 90 kRad / year 2*10 ¹¹ to 10 ¹² 1MeV n eq/cm ² |
| Rapid detector replacement (hot spare copy of the detector) | ~ 1 day |

356 M pixels on ~0.16 m^2 of Silicon

PXL architecture



Mechanical support with kinematic mounts (insertion side)



Cantilevered support

Ladder with 10 MAPS sensors (~ 2×2 cm each)





- Insertion from one side
- I0 sectors total
- 5 sectors / half
- 4 ladders / sector

HFT Status and Performance

HFT in Run-14



- IST, SSD installed into STAR in the fall 2013
- PXL inserted into STAR at the end of January 2014
- Commissioning of HFT detectors in February and March including Cosmic Ray data taking (extended SSD commissioning)
- Physics data taking March July
- Collected >1.2 Billion Au+Au @ 200 GeV events



HFT Status – Run14



11

• SSD

- The RDO runs at <20% dead-time at 1 kHz
 - The ultimate limit is due to old Si modules (circa 2000)
- 6% dead wafers
- 90 % of the strips are active in the remaining wafers
- Collected 172 M Au+Au events and 57 M He3+Au events



Ladder

IST - Hit map in Ladder vs APV (ZS)

• IST

- 864 readout chips and 110592 channels total
- More than 95% fully functional channels
- Hit efficiency ~99%
- S/N 15:1-30:1
- Coolant leak rate 0.5-1.0% per day (subsequently fixed)
- Participated in data taking for He3+Au collisions

PXL damage in Run 2014





- Post-run investigation: latch-up tests at the 88" Cyclotron @LBL
 - Measure latch-up cross-sections Vs over-current protection threshold
 - Reproduce damage seen during the run
 - Define a safe operation envelope for Runs 2015/2016:
 - ver-current threshold ≤ 120mA above operating current



PXL Alignment

• PXL hit residual distributions before and after PXL alignment



- Consistent with expectations for alignment and momentum of muons
- $\sigma \sim 25 \mu m$ for inner layer and 50 μm for outer layer



HFT Pointing Resolution Performance- Run 14



200 GeV Au+Au event

HFT in Run-15



Now

RHIC run15: Current plan

| | • | | | 1 | 3 Fe | b | | 27 | Apr | 4 | Мау | 8 | Jun | | 11 | Jun |
|--|---|--|---|---|------|---|---------|------|--------|---|---------|----|-----|---|----|-----|
| RHIC STAR & PHENIX | | | | | | | | | | | \ | | | | 22 | Jun |
| RHIC Research with $\sqrt{s} = 200 \text{ GeV } pp$ | | | 2 | | ġ. | | 10.9 we | eeks | 3 ; | | 7 | | . / | | | |
| RHIC Research with $\sqrt{s} = 200 \text{ GeV/n pA}$ | u | | | | | | | | | | 🔪 5 wks | | / | [| | |
| RHIC Research with $\sqrt{s} = 200 \text{ GeV/n pA}$ | I | | | | | | | | | | 5 | .5 | | ľ | | |
| | | | | | | | | | | | | | 1 | | | |

- Main goal is to collect p-p and p-A (reference) data
- Used the refurbished PXL Run14 detector
 - All aluminum cable ladders on Inner layer
 - Improved protection against latch-up damage
 - Only ~5% damage per layer in Run15
- All HFT detectors operated well in Run15

HFT dataset goals for run15



STAR HFT

HFT goals for Run 16



- STAR/RHIC improvements vs. Run 14
 - PXL equipped with the Aluminum (AI) cable for inner ladders $0.52\% \rightarrow 0.38\% X_0$
 - − SSD at full speed \rightarrow better track matching
 - Increased luminosity fraction within |Vz|<5cm
- Beam request for Run 16:
 - 13 weeks Au+Au 200 GeV run
 - 2 B minimum bias events

Physics goals:

- More differential studies on charmed hadron production
- Λ_{c} measurement



- STAR Heavy Flavor Tracker was first fully installed and commissioned for the 2014 Au+Au RHIC run. This data set is now in production for physics analysis.
- The (preliminary) DCA pointing resolution performance of the installed HFT detectors appears to be as expected and meets the design goals
- Observed radiation related damage in the PXL detector appears to be halted by using operational methods
- A spare detector (with AI conductor cable on the inner ladders) is complete and ready to be deployed as needed.

MAPS is working well as a technology for vertex detectors

 The PXL detector is the first MAPS based vertex detector and as such leads the way for future vertex detectors based on MAPS technology (such as the ALICE ITS, etc.)

Thank you!







Backup Slides

IST characteristics





| φ-Coverage | 2π |
|-------------------------|---------|
| η -Coverage | ≤1.2 |
| Number of Staves | 24 |
| Number of hybrids | 24 |
| Number of sensors | 144 |
| Number of readout chips | 864 |
| Number of channels | 110592 |
| r- resolution | 172 µm |
| Z resolution | 1811 µm |
| R-ø pad size | 594 µm |
| Z pad size | 6275 µm |



| IST | stave | = Carbon | fiber | ladder |
|-----|-------|----------|-------|--------|
|-----|-------|----------|-------|--------|

- + Kapton flex hybrid
- + Passive components
- + 6 silicon pad sensors
- + 3 x 12 APV25-S1 readout chips
- + Aluminum cooling tube
- + Liquid coolant (3M Novec 7200)

IST staves were assembled/tested/surveyed at UIC/ FNAL and MIT/BNL sites (18 staves produced at each site).

PXL sensor threshold operation point



• The noise level was set at ~2 x 10⁻⁶ for the cosmic ray run. At this noise rate, the measured operating point (taken from beam tests) is shown above.



Threshold = Th_{1.5*10E-6 fake hit rate} – Offset _{from labThScan} σ_{noise} = 1.33 mV Threshold = 5.48 mV = 4.12 σ_{noise}

Engineering run 2013



 PXL Engineering Run assembly crucial to deal with a number of unexpected issues



Engineering run geometry







Sensor IR picture

- Flawed ladder dissection: searching for shorts
- Mechanical interference in the driver boards on the existing design.
- The sector tube and inner ladder driver board have been redesigned to give a reasonable clearance fit
- ▶ Inner layer design modification: ~ 2.8 cm inner radius

- Shorts between power and gnd, or LVDS outputs
- Adhesive layer extended in both dimensions to increase the portion coming out from underneath the sensors
- Insulating solder mask added to low mass cables



Inner layer design

- After the engineering run added functionality to the MTB:
 - remote setting of LU threshold and ladder power supply voltage + current and voltage monitoring

PXL hit efficiency



preliminary results based on the cosmic ray data Note: this data was taken before the final detector optimizations



PXL insertion



Yes – we push it in by hand



Unique mechanical design:

- detector is inserted along rails and locks into a kinematic mount on the insertion end of the detector
- Allows for rapid (1 day) replacement with a characterized spare detector

Kinematic mounts



Insertion of PXL detector



